

Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
20V	250mΩ@4.5V	0.75A
	350mΩ@2.5V	



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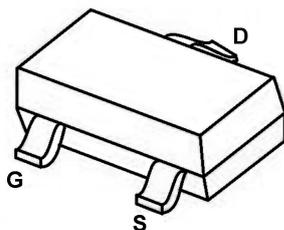
Feature

- High power and current handing capability
- Surface mount package
- ESD protected 2KV

Application

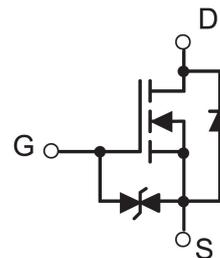
- Battery Switch
- DC/DC Converter

Package

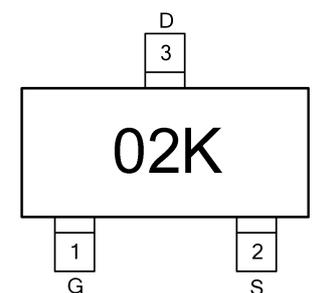


SOT-23

Circuit diagram



Marking



02K :Device Code

Order Information

Device	Package	Unit/Tape
SP2002KT2	SOT-23	3000

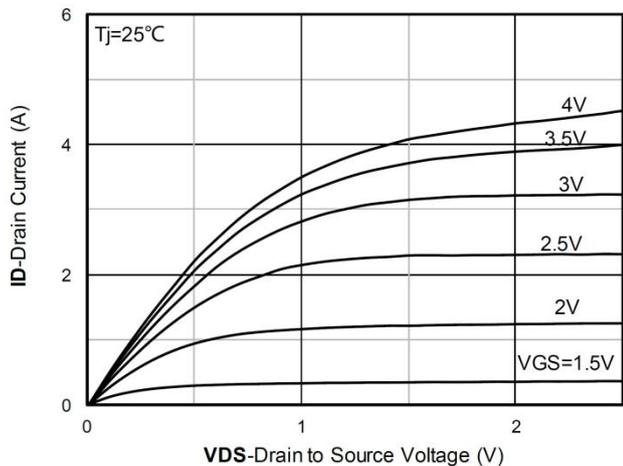
Absolute maximum ratings (Ta=25°C, unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _{DSS}	20	V
Gate-Source Voltage	V _{GSS}	±12	V
Continuous Drain Current	I _D	0.75	A
Pulse Drain Current Tested	I _{DM}	3	A
Power Dissipation	P _D	350	mW
Thermal Resistance Junction-to-Ambient	R _{θJA}	357	°C/W
Storage Temperature Range	T _{STG}	-55 to 150	°C
Operating Junction Temperature Range	T _J	-55 to 150	°C

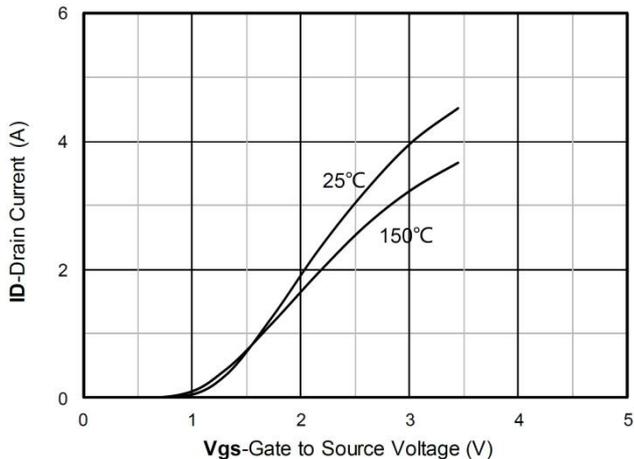
Electrical characteristics (Ta=25°C, unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V , I _D =250μA	20	-	-	V
Drain-Source Leakage Current	I _{DSS}	V _{DS} =16V , V _{GS} =0V	-	-	1	uA
Gate-Source Leakage Current	I _{GSS}	V _{GS} =±12V , V _{DS} =0V	-	-	±10	uA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	0.30	0.65	1.00	V
Static Drain-Source On-Resistance	R _{DS(ON)}	V _{GS} =4.5V , I _D =500mA	-	250	380	mΩ
		V _{GS} =2.5V , I _D =200mA	-	350	450	
Dynamic characteristics						
Input Capacitance	C _{iss}	V _{DS} =10V , V _{GS} =0V , f=1MHz	-	35	-	pF
Output Capacitance	C _{oss}		-	19	-	
Reverse Transfer Capacitance	C _{rss}		-	9	-	
Total Gate Charge	Q _g	V _{DS} =10V , V _{GS} =4.5V , I _D =500mA	-	0.8	-	nC
Gate-Source Charge	Q _{gs}		-	0.3	-	
Gate-Drain Charge	Q _{gd}		-	0.16	-	
Switching Characteristics						
Turn-On Delay Time	t _{d(on)}	V _{DD} =10V V _{GS} =4.5V , R _G =10Ω , I _D =500mA	-	4	-	nS
Turn-On Rise Time	t _r		-	19	-	
Turn-Off Delay Time	t _{d(off)}		-	10	-	
Turn-Off Fall Time	t _f		-	21	-	
Source-Drain Diode characteristics						
Diode Forward Voltage	V _{SD}	V _{GS} =0V , I _S =1A , T _J =25°C	-	-	1.2	V

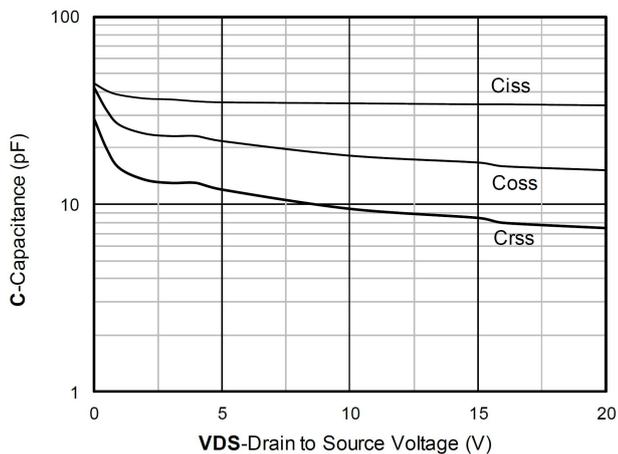
Typical Characteristics



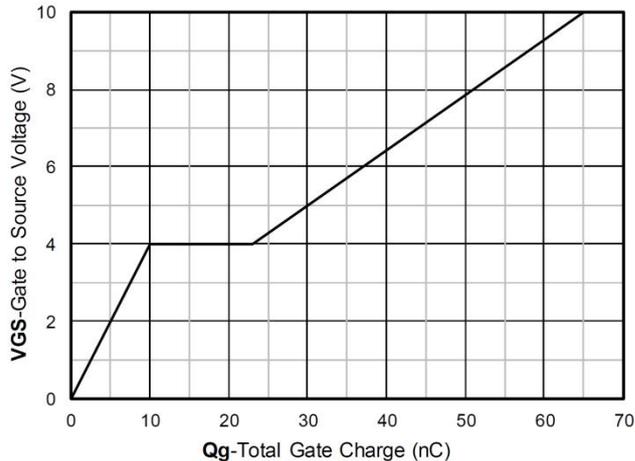
Output Characteristics



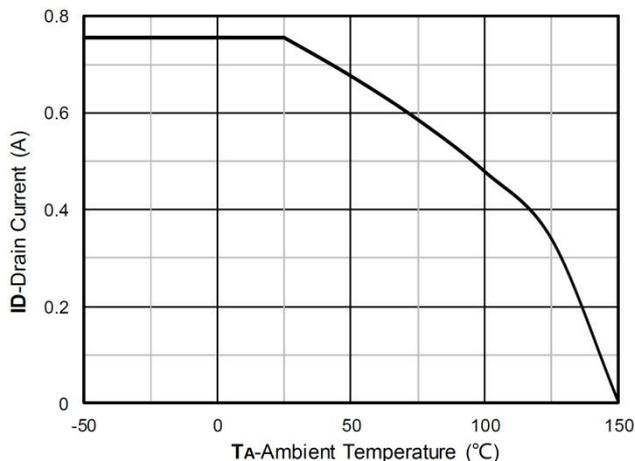
Transfer Characteristics



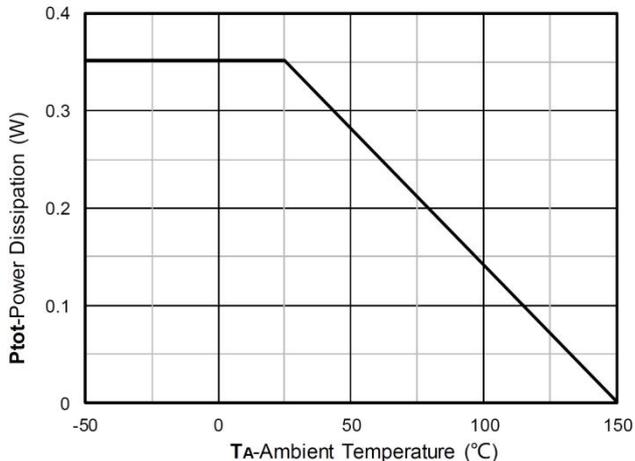
Capacitance Characteristics



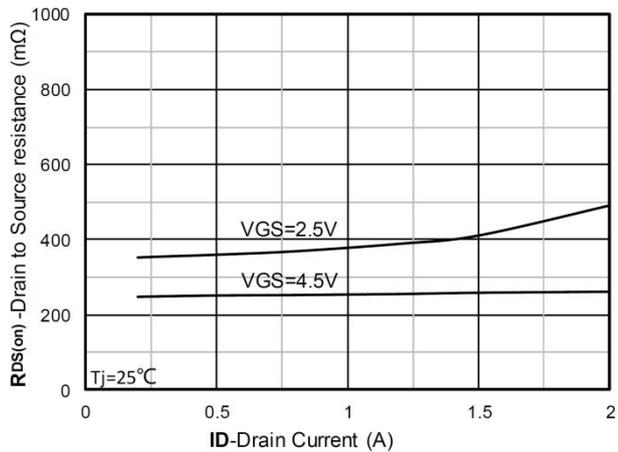
Gate Charge



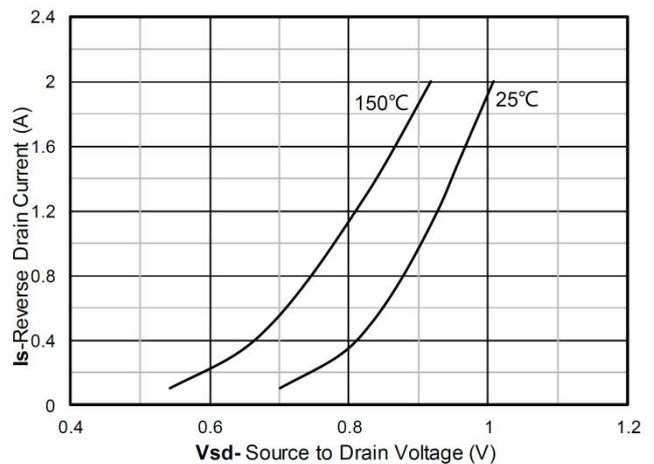
Current dissipation



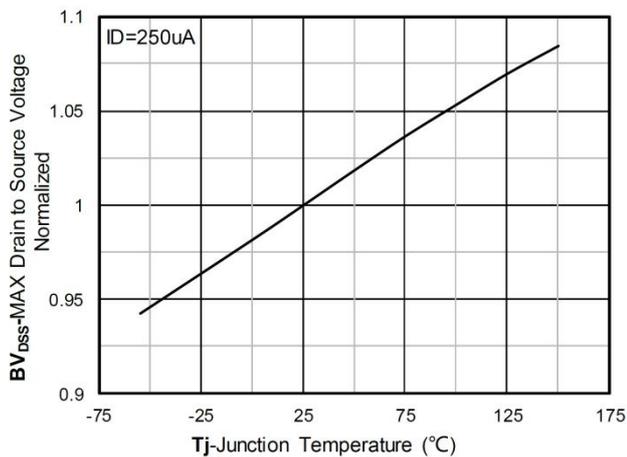
Power dissipation



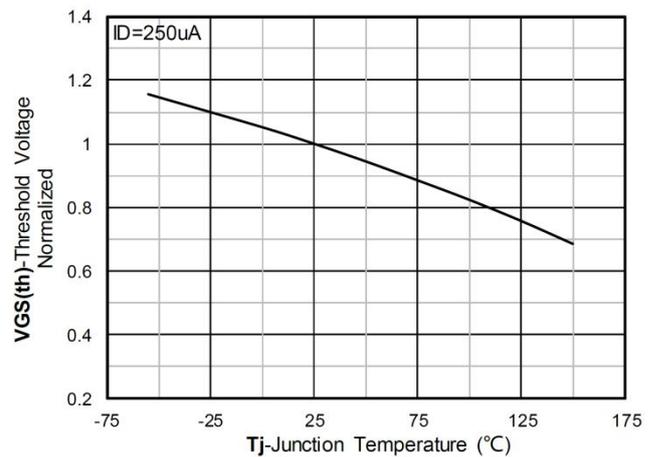
RDS(on) VS Drain Current



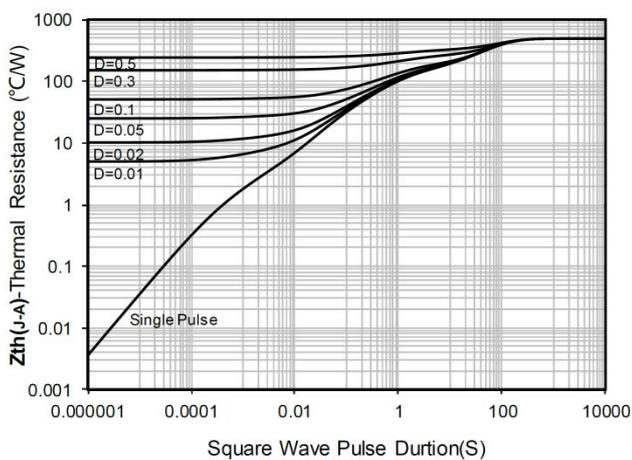
Forward characteristics of reverse diode



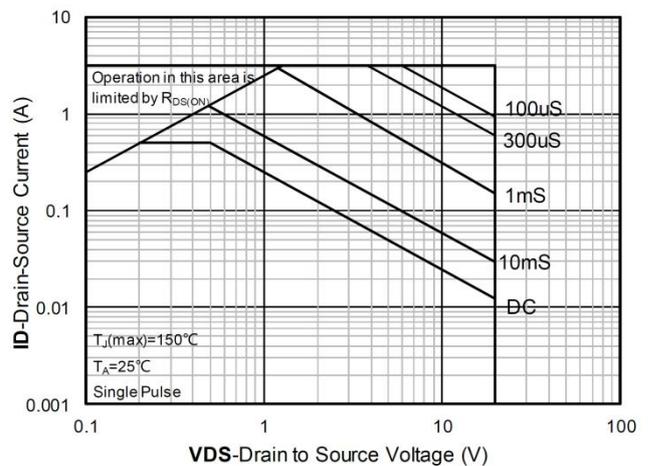
Normalized breakdown voltage



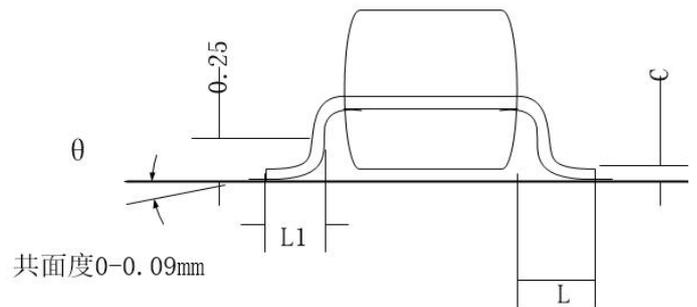
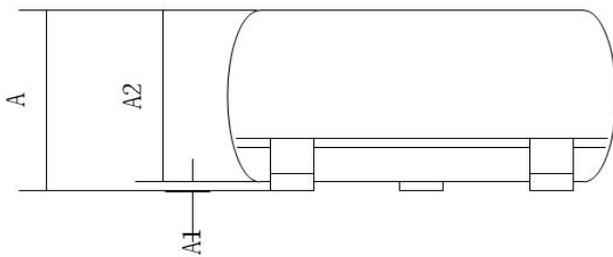
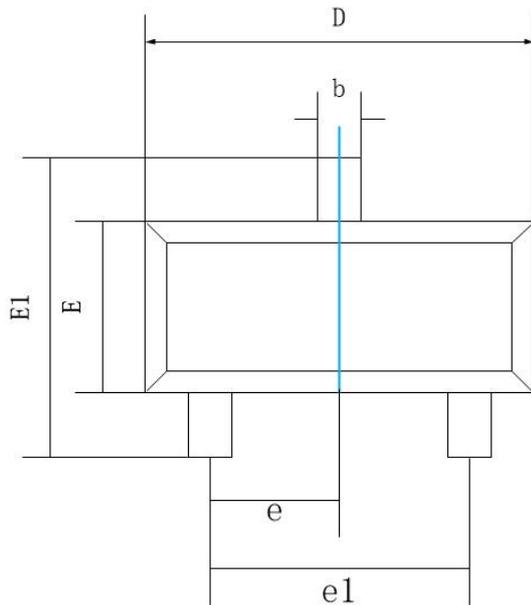
Normalized Threshold voltage



Maximum Transient Thermal Impedance



Safe Operation Area

SOT-23 Package Information


Symbol	Dimensions In Millimeters	
	Min.	Max.
A	0.90	1.15
A1	0.00	0.10
A2	0.90	1.05
b	0.30	0.50
c	0.08	0.15
D	2.80	3.00
E	1.20	1.40
E1	2.25	2.55
e	0.95 REF.	
e1	1.80	2.00
L	0.55 REF.	
L1	0.30	0.50
θ	0°	8°